# **SPECIFICATION**

May-03-2012

### OF

# LIQUID CRYSTAL DISPLAY MODULE

CUSTOMER :	STD	
Model No. :	UMSH-8596MD-19T	
Model version :	0	
Document Revisi	on: 3	

#### Preliminary

CUSTOMER APPROVED SIGNATURE					

This specification need to be signed by purchaser or customer as a specification of products production and delivery from URT. Without signature of this specification, any purchase order for this model no. will be treated and considered that this specification is automatically acknowledged and accepted by purchaser or customer.



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May-03-2012 Date

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Revision 3 ; UMSH-8596MD-19T Ver. 0 ; May-03-2012

Page: 1

This document has been signed by Digital Signature Approval System

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To Whom It May Concern:

In continuing to develop and promote the strategic partnership between United Radiant Technology (URT) and Microtips USA (MTUSA), URT is please to announce that we have entered into an agreement with MTUSA to support some key projects only through MTUSA and as such the attached spec with URT Part no. will be manufactured by URT but support and logistic of the sales will be handled by MTUSA.

URT is confident that this arrangement between our two companies will ultimately benefit the end customer.

Thank You. Raymond Chen

Ragmond hen

Sales Manager: URT

		Revision record	
Document	Model No.	Description	Revision
Revision	Version No.	Description	by
0	UMSH-8596MD-T		Y.D. Shie
0	(UFSH-K106EY-FT) Version No. 0	7.0" TFT.( backlight luminance 300cd/m <sup>2</sup> )	Zi Xin Ou 25-May-2011
1	UMSH-8596MD-1T	Modify the backlight luminance from 300cd/m <sup>2</sup> to	Y.D. Shie
1	(UFSH-K106EY-FT) Version No. 0	500cd/m <sup>2</sup> .	Zi Xin Ou 10-Jun-2011
2	UMSH-8596MD-11T	1. Modify the interface pin from DE mode to LVDS 18 bit mode.	Y.D. Shie
2	(UFSH-K106EY-FT) Version No. 0	2. Modify the module number from UMSH-8596MD-1T to UMSH-8596MD-11T.	Zi Xin Ou
3	UMSH-8596MD-19T	1. Add the capacitive touch panel.	Y.D. Shie
3	(UFSH-K106EY-FT) Version No. 0	<ul><li>(Two Finger multi Touch , two Fingers detection)</li><li>2. Modify the module number from UMSH-8596MD-11T to UMSH-8596MD-19T.</li></ul>	Zi Xin Ou 03-May-2012
////// Mica Tech	rotips nology Revision 3	; UMSH-8596MD-19T Ver. 0 ; May-03-2012	Page: 2

## **CONTENTS:**

No.	Item	Page
	BASIC SPECIFICATION	
1	1.1 Mechanical Specification	4
	1.2 Display Specification	4
	1.3 Outline Dimension	5
	1.4 Block Diagram	6
	1.5 Interface Pin	7
	ELECTRICAL CHARACTERISTICS	
2	2.1 Absolute Maximum Ratings	8
	2.2 DC Characteristics	9
	2.3 Back-light	10
	2.4 AC Characteristics	11~13
	2.5 Capacitive touch panel controller AC Characteristics	s 14
	2.6 I2C Host Interface Protocol	15~17
	OPTICAL CHARACTERISTICS	
3	3.1 Condition	18
	3.2 Definition of Optical Characteristics	19~20
4	RELIABILITY	21
5	PRODUCT HANDING AND APPLICATION	22
6	DATECODE	23
7	PACKING & LOTNO	24~25
8	INSPECTION STANDARD	26~29

#### **1. BASIC SPECIFICATION**

#### **1.1 Mechanical specifications**

Items	Nominal Dimension	Unit
Active screen size	7.0" Diagonal	_
Dot Matrix	800 x RGB x 480	dots
Module Size (W x H x T)	165.0 x 106.4 x 8.2	mm.
Active Area (W x H)	152.4 x 91.44	mm.
Pixel Size ( W×H )	0.1905 x 0.1905	mm.
Color depth	262K	color
Interface	LVDS - 18-bit	-
Driving IC Package	COG	-
Module weight	197	g

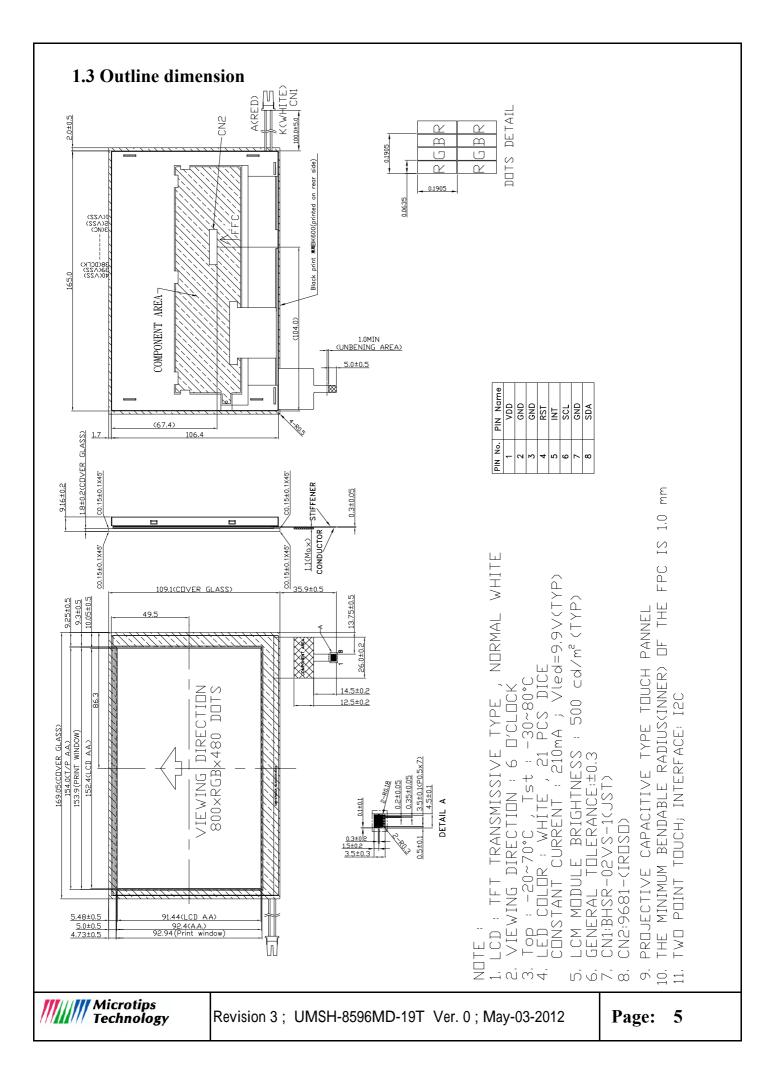
#### **1.2 Display specification**

Display	Descriptions	Note
LCD Type	a-Si TFT	
LCD Mode	TN / Normal white	
Polarizer Mode	Transmissive	
Polarizer Surface	Normal	
Pixel arrangement	RGB-stripe	
Backlight Type	LED	
Viewing Direction(Gray inversion)	6 O'clock Direction	1

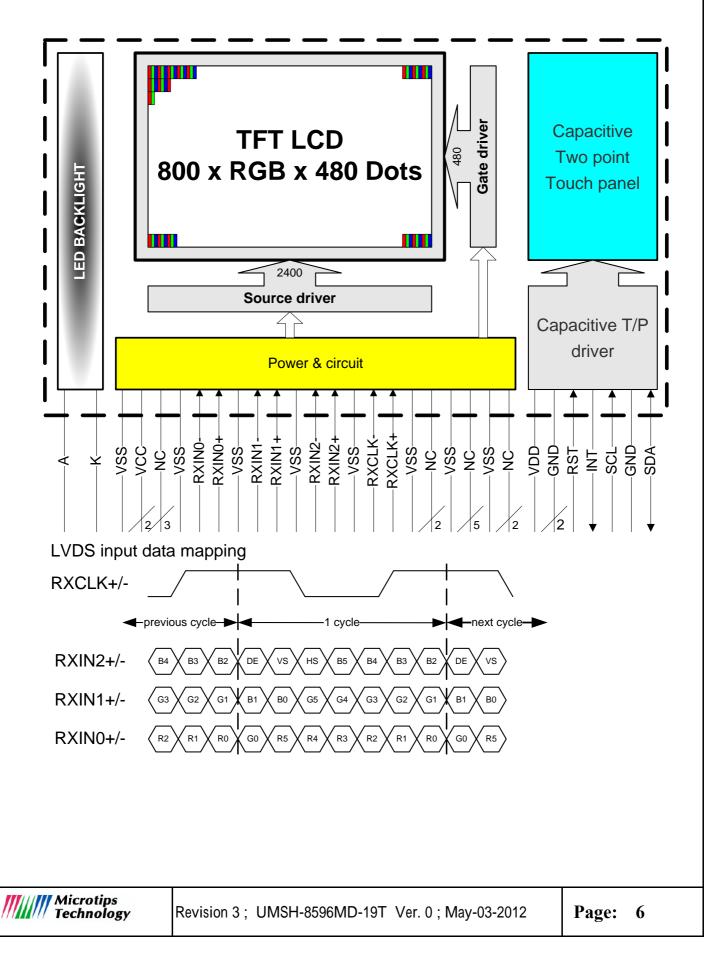
\*Color tone is slightly changed by temperature and driving voltage.

Note 1 : The viewing direction defined in this specification follows the rubbing direction of its mother TFT surface treatment.

The grayscale inversion is at this direction as well. The optimized viewing direction applied into end-device is decided by customers.



# 1.4 Block diagram:



# 1.5 Interface pin

Pin No.	Pin Symbol	I/O	Description
1	VSS	P	GND
2~3	VCC	P	Power supply for Module (+3.3V)
4~6	NC	-	No connection
7	VSS	P	GND
8	RXIN0-	I	Negative LVDS differential data inputs
9	RXIN0+	I	Positive LVDS differential data inputs
10	VSS	P	GND
11	RXIN1-	Ī	Negative LVDS differential data inputs
12	RXIN1+	I	Positive LVDS differential data inputs
13	VSS	P	GND
14	RXIN2-	I	Negative LVDS differential data inputs
15	RXIN2+	I	Positive LVDS differential data inputs
16	VSS	P	GND
17	RXCLK-	I	Negative LVDS differential clock inputs
18	RXCLK +	I	Positive LVDS differential clock inputs
19	VSS	P	GND
20~21	NC	-	No connection
22	VSS	P	GND
23~27	NC	-	No connection
28	VSS	P	GND
29~30	NC	-	No connection
B/L interfac	cepin:		
Pin No.	Pin Symbol	I/O	Description
1	A	P	Power supply for LED+
2	K	P	Power supply for LED-
Capacitive t	ouch panel (I2C	) Interf	ace:
Pin No.	Pin Symbol	I/O	Description
1	VDD	P	Power supply. (+3.3V)
2~3	GND	P	Ground.
4	RST	I	System reset signal input, active low. Note (1)
5	INT	0	Active low when data output from touch panel.
6	SCL	I	Serial Clock.
7	GND	P	Ground
8	SDA	10	Serial data access.
-			nd needs hold low for 1 ms to take effect

Note (1): Reset pin is low active and needs hold low for 1ms to take effect.

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# 2. ELECTRICAL CHARACTERISTICS

# 2.1 Absolute Maximum Ratings

Items	Symbol	Min.	Max.	Unit
Power supply voltage	VCC	-0.3	7.0	V
Power supply voltage	VDD	2.4	3.6	V
Input voltage	Vin	-0.3	VCC+0.3	V
Operate temperature range	TOP	-20	70	°C
Storage temperature range	Tst	-30	80	°C

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# **2.2 DC Characteristics**

 $T_a=25^\circ C$ 

Items	Symbol	Min.	Тур.	Max.	Unit	Condition
	VCC	-	3.3	-	V	-
Supply voltage	VDD	-	3.3	-	V	-
1	V <sub>IL</sub>	0	-	0.3VCC	V	L level
Input Voltage	V <sub>IH</sub>	0.7VCC	-	VCC	V	H level
	I <sub>VCC</sub>	-	180	280	mA	Note 1
Current consumption	I <sub>VDD</sub>	-	6	12	mA	-

\*Note1 :

Measuring Condition:

Standard Value MAX.

Ta = 25℃

VCC -GND = 3.3V

Display Pattern = Check pattern



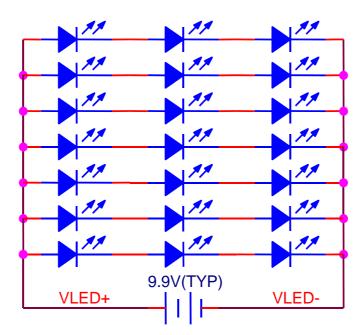
0 gray black pattern

# 2.3 Back-light Characteristics

PARAMETER	SYMBOL	MIN	ТҮР	MAX	Unit	Test Condition	NOTE
Supply Current	If	-	210	-	mA	Ta=25℃	-
Supply Voltage	Vf	-	9.9	-	V	Ta=25℃	-
Half-Life Time	Lf	-	50000	-	hrs	Ta=25℃	1

Note 1 : The "Half-Life Time" is defined as the LED chip brightness decreases to 50% than original brightness, Based on Ta 25±2°C,60±10% RH condition.

Note 2 : LED backlight is 21 LEDs.



# 2.4 AC Characteristics

Switching characteristics

PARAMETER	Symbol		Spec.		Unit
FARAMETER	Symbol	Min.	Тур.	Max.	Onit
HS setup time	T <sub>hst</sub>	6	-	×	ns
HS hold time	T <sub>hhd</sub>	6	-	-	ns
VS setup time	T <sub>vst</sub>	6	-	~	ns
VS hold time	T <sub>vhd</sub>	6	-	-	ns
Data setup time	T <sub>dsu</sub>	6	-	-	ns
Data hold time	T <sub>dhd</sub>	6	-	-	ns
DE setup time	T <sub>esu</sub>	6	-	-	ns
Source output settling time	T <sub>ST</sub>	-	-	15	μs
Source output loading R	R <sub>SL</sub>	-	2	-	K ohm
Source output loading C	C <sub>SL</sub>	-	60	-	pF

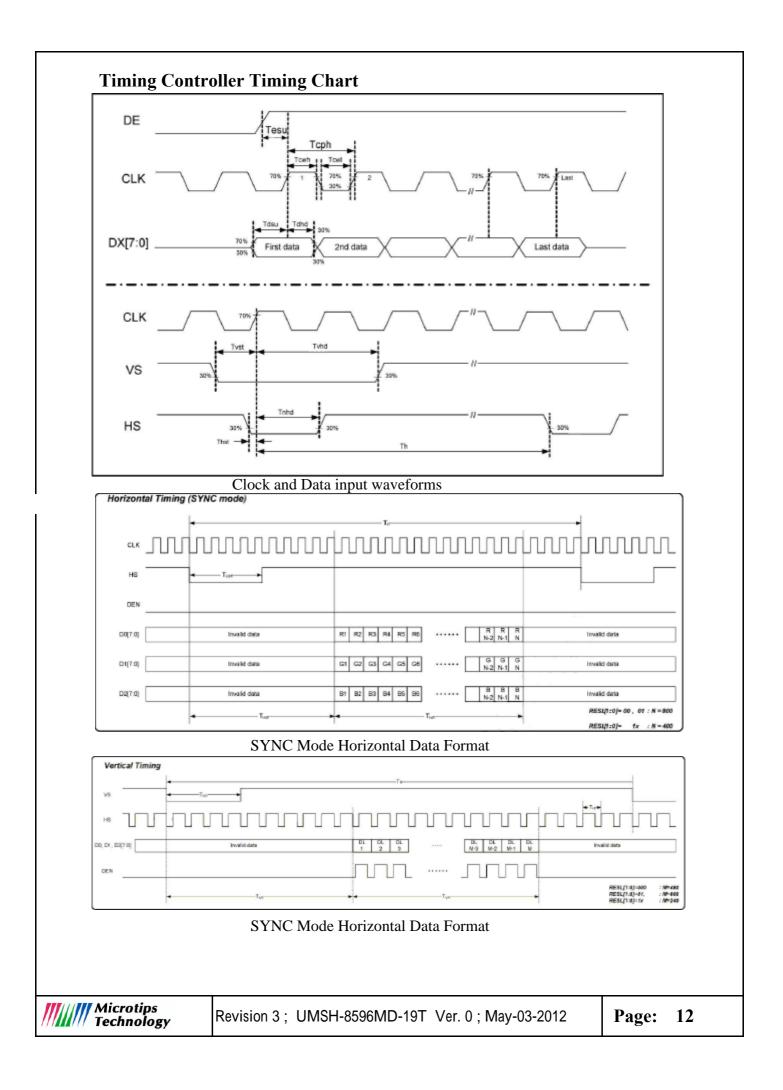
Parallel RGB Input Timing Requirement

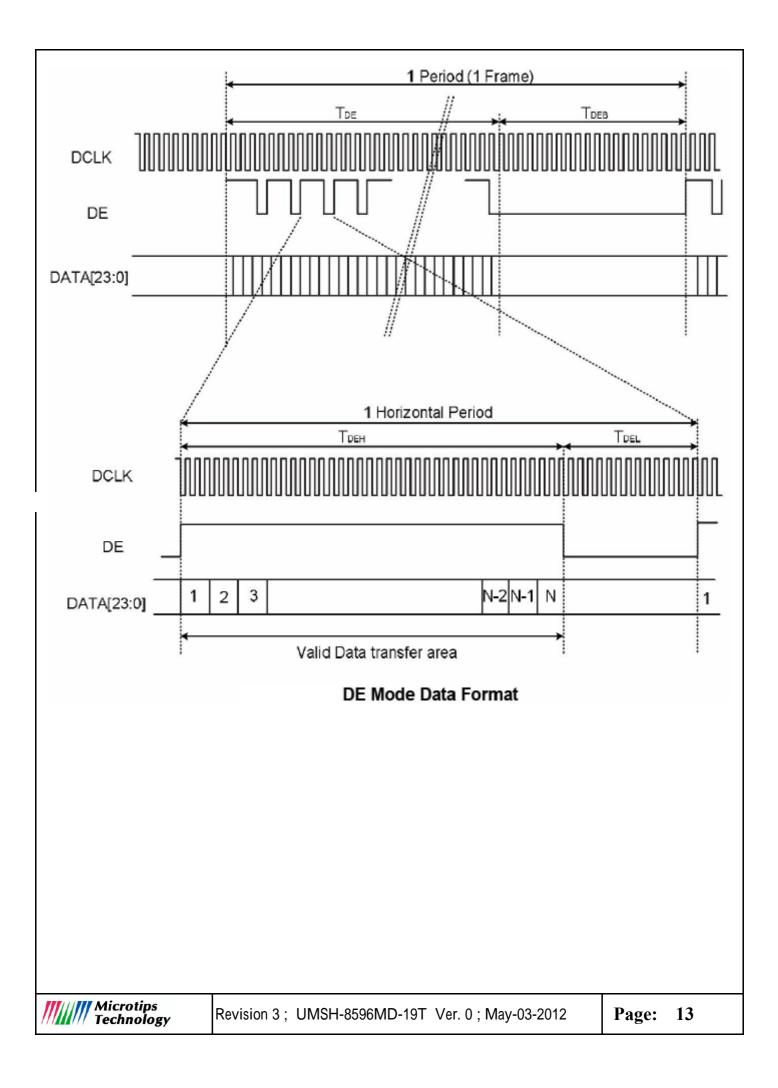
#### sync mode

PARAMETER	Symbol		Unit		
FARAMETER	Symbol	Min.	Тур.	Max.	Unit
CLK frequency	F <sub>CPH</sub>	-	33.26	~	MHz
CLK period	T <sub>CPH</sub>		30.06		ns
CLK pulse duty	T <sub>CWH</sub>	40	50	60	%
HS period	T <sub>H</sub>	930	1056	1057	T <sub>CPH</sub>
HS pulse width	T <sub>WH</sub>	1	128	-	T <sub>CPH</sub>
HS-first horizontal data time	T <sub>HS</sub>	STHD[7:0]+88 <sup>(i)</sup>			T <sub>CPH</sub>
HS Active Time	T <sub>HA</sub>	-	800	Ξ.	T <sub>CPH</sub>
VS period	Τv	-	525	-	T <sub>H</sub>
VS pulse width	Twv	1	2	~	T <sub>H</sub>
VS-DE time	T <sub>vs</sub>	S	STVD[6:0]+	8	T <sub>H</sub>
VS Active Time	T <sub>VA</sub>	-	480	-	T <sub>H</sub>
DE mode					

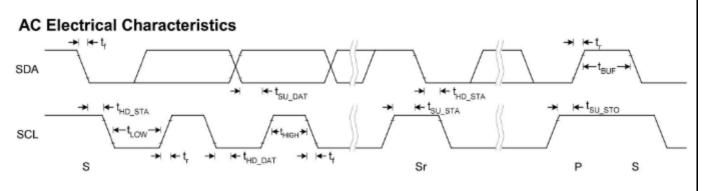
PARAMETER	Cumbal		Spec.		Unit
PARAMETER	Symbol	Min.	Тур.	Max.	Unit
CLK frequency	F <sub>CPH</sub>		33.26	-	MHz
CLK period	T <sub>CPH</sub>	-	30.06	-	ns
CLK pulse duty	T <sub>CWH</sub>	40	50	60	%
DE period	T <sub>DEH</sub> +T <sub>DEL</sub>	1000	1056	1200	T <sub>CPH</sub>
DE pulse width	TDEH	-	800	- 1	T <sub>CPH</sub>
DE frame blanking	T <sub>DEB</sub>	10	45	110	T <sub>DEH</sub> +T <sub>DEL</sub>
DE frame width	T <sub>DE</sub>		480	-	T <sub>DEH</sub> +T <sub>DEL</sub>
OEV pulse width	TOEV	-	150	-	T <sub>CPH</sub>
CKV pulse width	Тски	-	133	-	T <sub>CPH</sub>
DE(internal)-STV time	T <sub>1</sub>	-	4	-	T <sub>CPH</sub>
DE(internal)-CKV time	T <sub>2</sub>	-	40	-	T <sub>CPH</sub>
DE(internal)-OEV time	T <sub>3</sub>	-	23	-	T <sub>CPH</sub>
DE(internal)-POL time	T <sub>4</sub>	-	157	-	Т <sub>СРН</sub>
STV pulse width	-	-	1	-	T <sub>H</sub>

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# 2.5 Capacitive touch panel controller AC Characteristics



I2C Fast Mode Timing

I2C Fast Mode Timing Characteristic

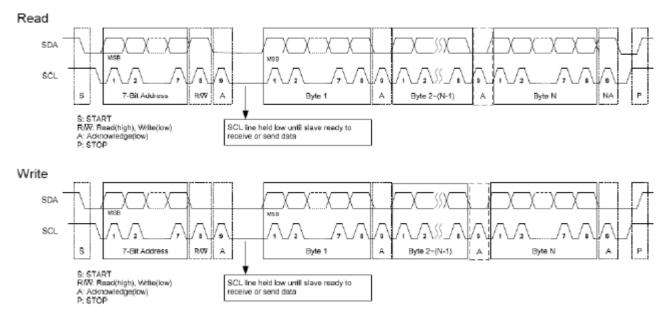
Conditions: VDD = IOVDD = 3.3V, GND = 0V, T<sub>A</sub> = 25°C

Symbol	Parameter		Rating		Unit
Cynnoor		Min.	Тур.	Max.	•
f <sub>SCL</sub>	SCL clock frequency	0	-	400	kHz
t <sub>LOW</sub>	Low period of the SCL clock	1.3	-	-	us
t <sub>HIGH</sub>	High period of the SCL clock	0.6		-	us
t <sub>f</sub>	Signal falling time	-	-	300	ns
t,	Signal rising time	-	-	300	ns
t <sub>su_sta</sub>	Set up time for a repeated START condition	0.6	-	-	us
t <sub>hd_sta</sub>	Hold time (repeated) START condition. After this period, the first clock pulse is generated	0.6	-	-	us
t <sub>su dat</sub>	Data set up time	100	-	-	ns
t <sub>HD DAT</sub>	Data hold time	0	-	0.9	us
t <sub>SU STO</sub>	Set up time for STOP condition	0.6	-	-	us
t <sub>BUF</sub>	Bus free time between a STOP and START condition	1.3	-	-	us
Cb	Capacitive load for each bus line	-	-	400	pF

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# 2.6 I2C Host Interface Protocol

#### I2C Slave Interface



#### 2.6.1 Register Read

For reading register value from I2C device, host has to tell I2C device the *Start Register Address* before reading corresponding register value.

I2C Start	I2C Header (W)	Start Reg. Addr. (a)	I2C Stop	I2C Start	I2C Header (R)	Value of Reg(a)	Value of Reg(a+1)		Value of Reg(a+n)	I2C Stop	
--------------	----------------------	-------------------------------	-------------	--------------	----------------------	--------------------	----------------------	--	----------------------	-------------	--

Figure 1. Register Read Format.

ST1232/ST1332 I2C host interface protocol supports *Repeated Register Read*. That is, once the *Start Register Address* has been set by host, consequent I2C Read(R) transactions will directly read register values starting from the *Start Register Address* without setting address first, as shown in Figure 2.

I2CValueValue ofValue ofValue ofI2CI2CStart(R)Reg(a)Reg(a+1)Reg(a+n)StopStart	Header of
---	-----------

Header Value : 0xab

Figure 2. Repeated Register Read.

#### 2.6.2 Register Write

For writing register to I2C device, host has to tell I2C device the Start Register Address in each I2C Register Write transaction. Register values to the I2C device will be written to the address starting from the Start Register Address described in Register Write I2C transaction as shown in Figure 3.

Ċ	I2C Start	I2C Header (W)	Start Reg. Addr. (a)	Value to Reg(a)	Value to Reg(a+1)		Value to Reg(a+n)	l2C Stop
_			Figu	re 3. Regis	ter Write Fo	rmat.		

Header Value : 0xaa

Microtips Technology	Revision 3; UMSH-8596MD-19T Ver. 0;May-03-2012	Page: 15
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# 2.6.3 Registers

ST1332 provides a register set for host to configure device attributes and retrieve information about fingers,

			Host In	iterface Regist	ers (Report P	age)					
Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0x00					Res	erved					
0x01					10030						
0x02	Device Control Reg		Rese	erved	Reserved	Power Down (R/W)	Reset (R/W)				
0x03	Timeout to Idle Register					o Idle (Sec) /W)					
0x04 ~ 0x0F			Reserved								
0x10	Fingers		Reserved Fingers(RO)								
0 x1 1					Res	erved					
0x12	XYO Coord (High Byte)	Valid 0 ( RO)		XO_H(RO)		Reserved		Y0_H (RO)			
0x13	XD Coord (Low Byte)				X0_1	L(RO)					
0x14	YO Coord ( Low Byte)				Y0_I	L(RO)					
0x15	XY1 Coord (High Byte)	Valid 1 (RO)	X1 H(R(I) Received V1 H(R(I)								
0x16	X1 Coord ( Low Byte)		X1_L(RO)								
0x17	Y1 Coord (Low Byte)		Y1_L(RO)								

## 2.6.4 Device Control Register

Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x02	Device Control Reg		Rese	rved		Reserved	Reserved	Power Down (R/W)	Reset (R/W)

Device Control Register provides device control bits for host to reset the device, power down the device.

### 2.6.5 Timeout to Idle Register

Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x03	Timeout to Idle Register		Timeout to Idle (Sec) (R/W)						

Timeout to Idle Register provides timeout control to entering Idle Mode for host.

The touch controller will enter Idle Mode after the number of seconds specified in Timeout to Idle Register if there is

no touch detected in this period.

Set the field to 0xFF will disable Idle Mode. Set the field to 0 will entering Mode immediately.

The default value of Timeout to Idle Register is set to 0x08 for 8 seconds to Idle Mode.

### 2.6.6 Fingers Register

Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x10	Fingers		Rese	erved			Finger	s(RO)	

Fingers field represents number of fingers detected by touch controller.

The coordinates of each finger detected are represents in X Coordinate and Y Coordinate fields.

# 2.6.7 XY Coordinate Registers

Reg Addr.	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0x12	XYO Coord (High Byte)	Valid 0 ( RO)		X0_H(RO) Reserved Y0_H						
0x13	XO Coord (Low Byte)				XO_L	.(RO)				
0x14	YO Coord ( Low Byte )				YO_L	.(RO)				
0x15	XY1 Coord (High Byte)	Valid 1 ( RO)		X1_H(RO)		Reserved		Y1_H (RO)		
0x16	X1 Coord (Low Byte)		X1_L(RO)							
0x17	Y1 Coord (Low Byte)		Y1_L(RO)							

XY Coordinate Registers represent the XY coordinates for each touch point ID.

Valid bit field tells that this point ID is valid and the XY information represents a real touch point on touch sensor.

# **3. OPTICAL CHARACTERISTICS**

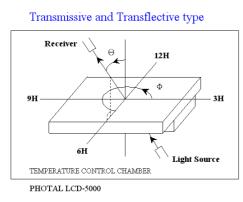
### 3.1 Characteristics

No.	Item		symb	ol / temp.	Min.	Тур.	Max.	Unit	Note
1	Response	Time	Tr	25	NA	5	10	ms	2
			Tf	25	NA	15	20	1115	2
		Hor.	2+		60	85	-		
2	Viewing	1101.	2-	Center	60	85	-	degree	3
2	Angle	Ver.	1+	CR>=10	60	85	-	uegree	5
		v c1.	1-		60	85	-		
3	Contrast F	Ratio	Cr	25	700	1000	-	-	4
	Red x-code		Rx		0.54	0.58	0.64		
	Red y-cod	e	Ry		0.30	0.35	0.40		
	Green x-c	ode	Gx		0.30	0.35	0.40		
	Green y-c	ode	Gy		0.52	0.57	0.62		5
4	Blue x-coo	de	Bx	25	0.10	0.15	0.20	-	
	Blue y-co	de	By		0.08	0.13	0.18		
	White x-c	ode	Wx		0.26	0.31	0.36		
	White y-code		Wy		0.29	0.34	0.39		
	Brightness	Y		300	400	-	cd/m <sup>2</sup>		
5	Brightness Uniformi			25	80	-	-	%	6

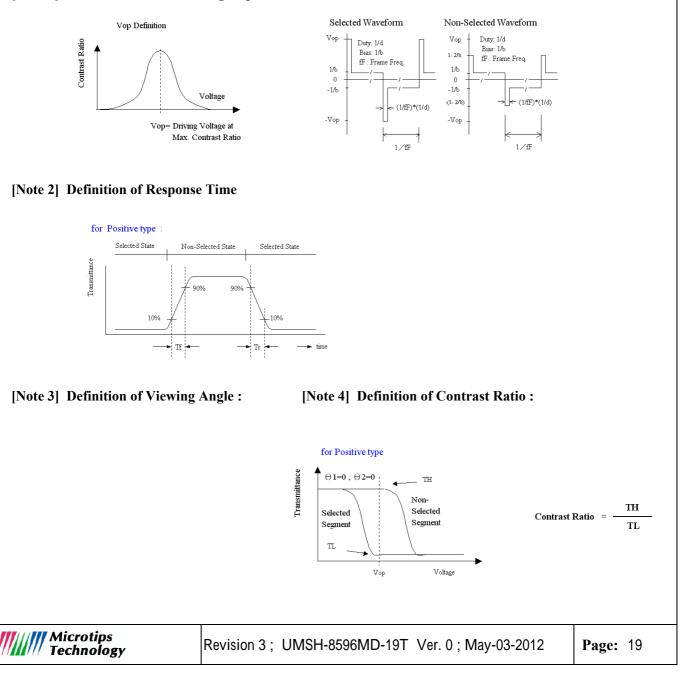
Electrical and Optical Characteristics

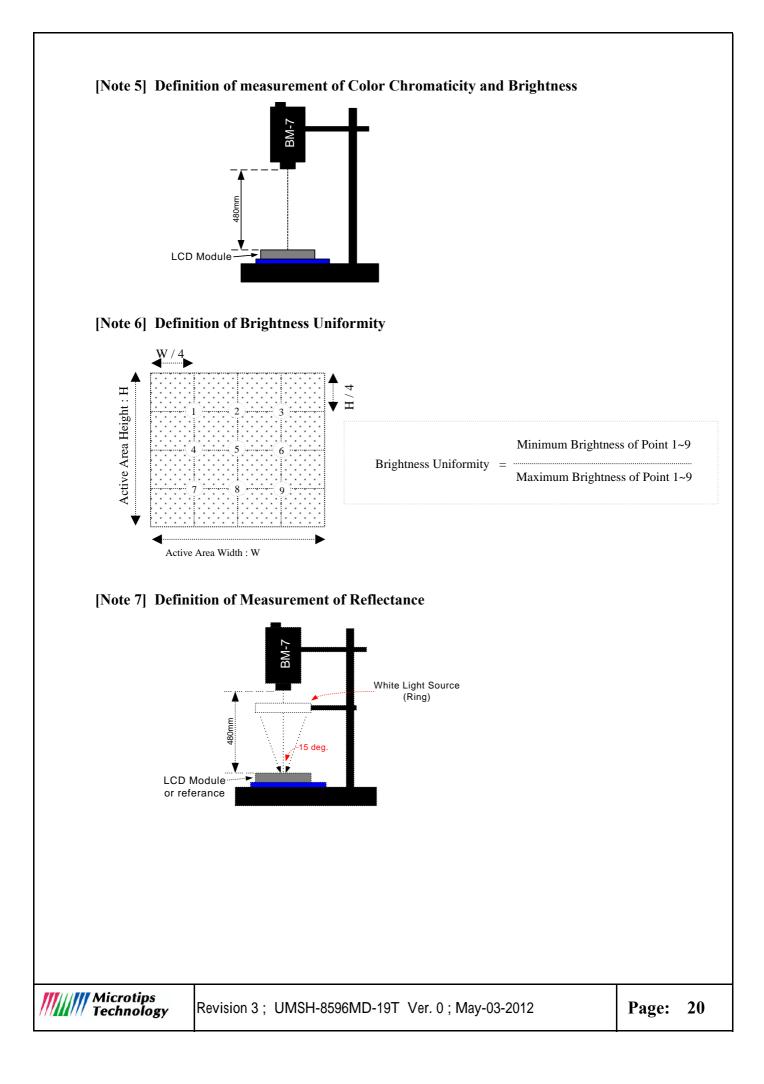
### 3.2 Definition of optical characteristics

#### **Measurement condition :**



#### [Note 1] Definition of LCD Driving Vop and Waveform :





### 4. RELIABILITY :

Item No	Items	Condition
1	High temperature operating	70 , 200 hours
2	Low temperature operating	-20 , 200 hours
3	High temperature storage	80 , 200 hours
4	Low temperature storage	-30 , 200 hours
5	High temperature & humidity storage	60 , 90%RH, 100 hours
6	Thermal Shock storage	-30 , 30min.<=> 80 , 30min. 10 Cycles
7	Vibration test	$10 \Rightarrow 55 \Rightarrow 10 \Rightarrow 55 \Rightarrow 10$ Hz, within 1 minute Amplitude : 1.5mm. 15 minutes for each Direction (X,Y,Z)
8	Drop test	Packed, 100CM free fall, 6 sides, 1 corner, 3edges
9	Life time	50,000 hours 25 , 60% RH , specification condition driving

- \* One single product test for only one item.
- \* Judgment after test : keep in room temperature for more than 2 hours.
  - Current consumption < 2 times of initial value
  - Contrast > 1/2 initial value
  - Function : work normally

## 5. PRODUCT HANDLING AND APPLICATION

#### PRECAUTION FOR HANDLING LCM

The LCD module contains a C-MOS LSI. People who operate the LCM should wear ESD protection eguipement to prevent ESD hurt on products.

Do not input any signal before power is turned on.

Do not take LCM from its packaging bag until it is assembled.

Peel off the LCM protective film slowly since static electricity may be generated.

Pay attention to the humidity of the work shop,  $50\sim60\%$  RH is satisfactory.

Use a non-leak iron for soldering LCM.

Do not touch the display surface or connection terminals area with bare hands.Smudges on the display surface reduce the insulation between terminals.

Cautions for soldering to LCM:

Condition for soldering I/O terminals:

Temperature at iron tip :350  $\pm 15$  .

Soldering time : 3~4sec./ terminals.

Type of solder : Eutectic solder(rosin flux filled).

#### PRECAUTION IN USE OF LCM

Do not contact or scratch the front surface and the contact pads of a LCM with hard materials such as metal or glass or with one's nail.

To clean the surface , wipe it gently with soft cloth dampened by alcohol.

Do not attempt to wiped off the contact pads.

Keep LCM panels away from direct sunlight, also avoid them in high-temperature & high humidity environment for a long period.

Do not drive LCM by DC voltage.

Do not expose LCM to organic solvent.

Liquid in LCM is hazardous substance. In case a contact with liquid crystal material is occured, be sure to immediately wash such material away by soap and water.

The polarizer is easily damaged and should be handle with special care. Don't press or rub it with hard objects.

### PRECAUTION FOR STORING AND USE OF LCM

To avoid degradation of the device , do not store the module under the conditions of direct sunlight , high temperature or high humidity . Keep the module in bags designed to prevent static electricity charging under low temperature / normal humidity conditions(avoid high

temperature / high humidity and low temperature below 0 )

Never use the LCD , LCM under 45 Hz , the liquid crystal will decomposition and cause permently damage on display !!

#### USING ON MEDICAL CARE, SAFETY OR HAZARDOUS APPLICATION OR SYSTEM

For the application in medical care, safety and hazardous prodcuts or systems, an authorization from URT is required. URT will not responsible for any damage or loss which caused by the products without any authorization given by URT.

This product is not allowed to be designed and used for military application and/or purpose.

The delivery of this product to the countries and/or regions where the embargoes

are imposed by U.N. is prohibited.

The application and delivery of this product must comply with Startegic High-Tech Commodities (SHTC) export control and the sales to the embargoed and/or sanctioned countries or regions are strictly prohibited.



# 6. DATE CODE OF PRODUCTS

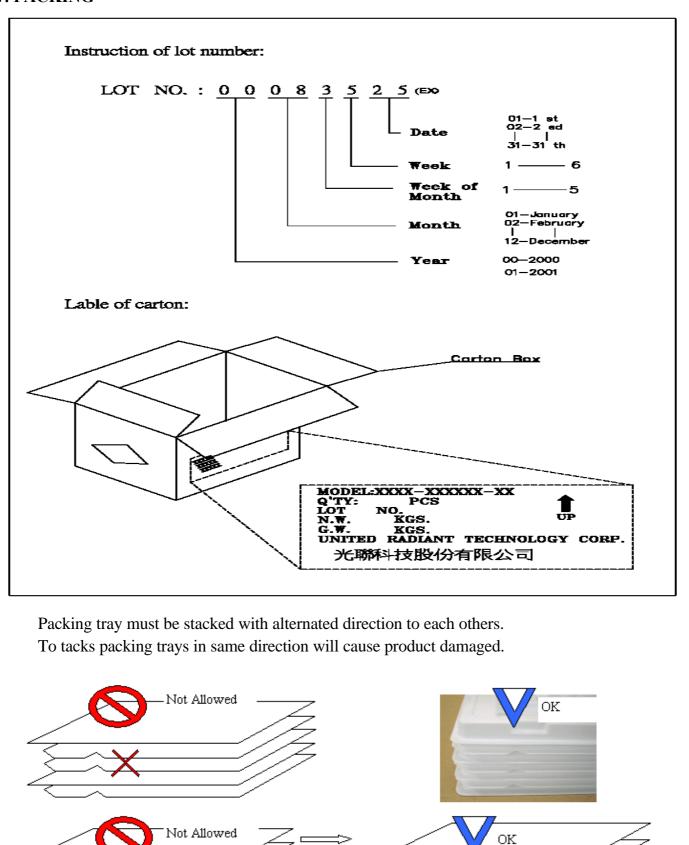
Date code will be shown on each product :

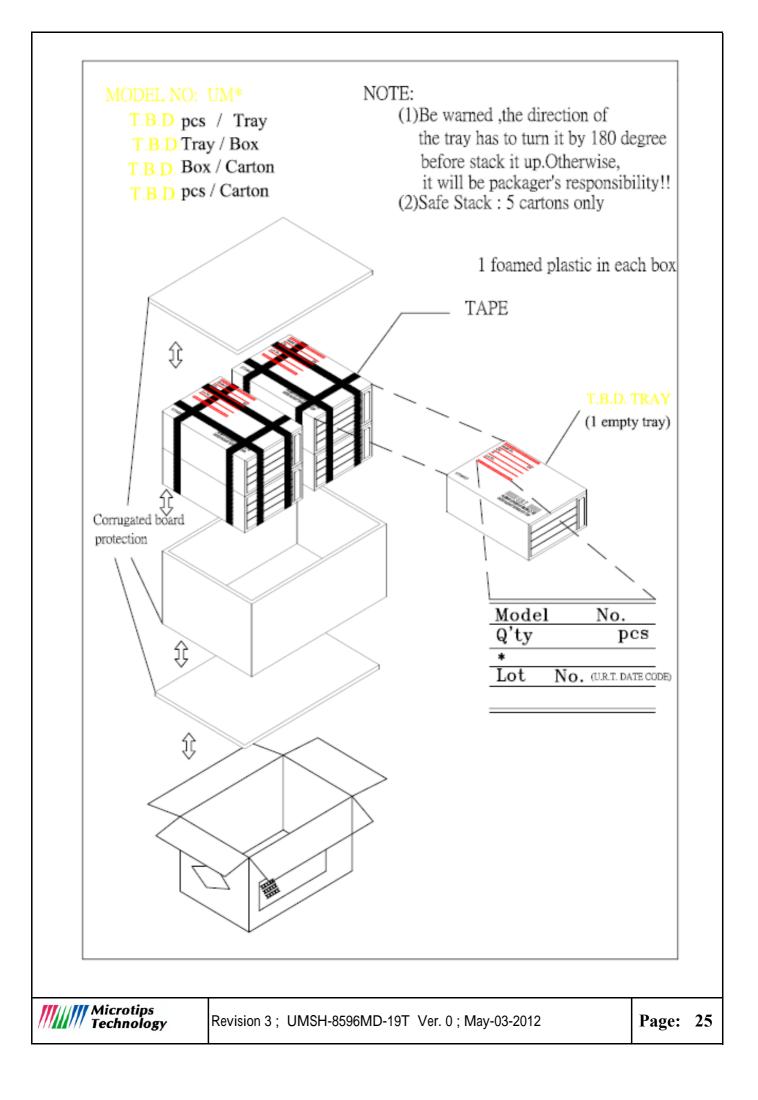
YY MM DD - XXXX

Year Month Day - Production lots

Example: 090508 - 0 0 0 3 ==>Year 2009, May.,08rd , Batch no.03

### 7. PACKING





### 8. INSPECTION STANDARD

#### **8.1. QUALITY :**

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD. 8.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM U.R.T. TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 TO 40 ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

#### **8.1.2. INCOMING INSPECTION**

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION , A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 ( or MIL-STD	-105E), LEVEL SINGLE PLAN	N.
CLASS	AQL(%)	
CRITICAL	0.4 %	
MAJOR	0.65 %	
MINOR	1.5 %	
TOTAL	1.5 %	

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

#### (C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

#### 8.1.3. WARRANTY POLICY

U.R.T. WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. U.R.T. WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF U.R.T.

#### **8.2. CHECKING CONDITION**

**8.2.1.** CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.

**8.2.2.** CHECKER SHALL SEE OVER 30 cm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.

#### **8.3. INSPECTION PLAN :**

CLASS	ITEM	JUDGEMENT	CLASS
	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY"	Minor
PACKING &		SHOULD INDICATE ON THE PACKAGE.	
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED	Critical
		QUANTITY SHORT OR OVERREJECTED	
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON	Major
		THE PRODUCT	
	4. DIMENSION,	ACCORDING TO SPECIFICATION OR	
ASSEMBLY	LCD GLASS SCRATCH	DRAWING.	Major
	AND SCRIBE DEFECT.		5
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE	Minor
		IS VISABLE IN THE VIEWING AREA	
		REJECTED	
	6. BLEMISH、 BLACK SPOT、	ACCORDING TO STANDARD OF VISUAL	Minor
	WHITE SPOT IN THE LCD	INSPECTION ( INSIDE VIEWING AREA )	
	AND LCD GLASS CRACKS		
	7. BLEMISH、 BLACK SPOT	ACCORDING TO STANDARD OF VISUAL	Minor
APPEARANCE	WHITE SPOT AND SCRATCH	INSPECTION ( INSIDE VIEWING AREA )	
	ON THE POLARIZER		
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL	Minor
		INSPECTION ( INSIDE VIEWING AREA )	
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR ( OR NEWTON	
		RING) OF LCDREJECTED.	Minor
		OR ACCORDING TO LIMITED SAMPLE	
		( IF NEEDED, AND INSIDE VIEWING AREA )	
	10. ELECTRICAL AND OPTICAL	ACCORDING TO SPECIFICATION OR	Critical
	CHARACTERISTICS	DRAWING . ( INSIDE VIEWING AREA )	
	(CONTRAST, VOP,		
	CHROMATICITY ETC )		
ELECTRICAL	11.MISSING LINE	MISSING DOT, LINE, CHARACTER	Critical
		REJECTED	
	12.SHORT CIRCUIT、	NO DISPLAY、 WRONG PATTERN	Critical
	WRONG PATTERN DISPLAY	DISPLAY、 CURRENT CONSUMPTION	
		OUT OF SPECIFICATION REJECTED	
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL	Minor
		INSPECTION	

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### 8.4 STANDARD OF VISUAL INSPECTION

NO.	CLASS	ITEM	JUDGEMENT										
			(A) R	OUND	TYF	PE:					unit : r	nm.	
				DIAM	ETI	ER (mr	n.)	A	CCEPT	ΓABLE	Q'TY		
		. BLEMISH、BLACK SPOT、	0.1					L	DISREGARD				
		WHITE SPOT IN THE LCD.	0.1 < 0.2					2					
			0.2 < 0.25			25		1					
8.4.1 MI				0.25 <	<					0			
	MINOR	. BLEMISH、BLACK SPOT、		NOTE:	=(	LENGT	H+WID	DTH)/2	2				
		WHITE SPOT AND SCRATCH	(B) L	INER T	YPF	:						unit : m	m.
		ON THE POLARIZER	LENGTH WIDTH			Н		ACCEI	PTABL	e q'ty	r		
							W		0.03		DISRE	GARD	
				L 5.	-	).03 <	W		0.05		3		
				L 5.		).05 <	W		0.07		1		
					(	0.07 <	W			FOLLOW	V ROUN	D TYPE	
										ЕРТАР	unit:r		
		BUBBLE IN POLARIZER	DIAMETER 0.15			15	ACCEPTABLE Q'TY DISREGARD						
8.4.2	MINOR			0.15 < 0.5			_						
				0.13 <			U			0			
				`						0			
	Dot Defect	Pixel	e				N 4	Y					
				R	G	В	R	G	В	R	G	в	]
							•••	Ŭ		.`	Ľ,	<u> </u>	4
8.4.3 MINOR	MINOP			R	G	В	R	G	В	R	G	В	
5.7.5				R	G	В	R	G	В	R	G	в	
			Not 2 Not 3	2: Brig in wh 3: Dark which ,blue	wh ht c ich dc LC patt	iole do lot: Do LCD f t: Dots CD pan ern.	t is re ots app oanel i s appe nel is c	gard bear l is dis ear da displa	ed as bright playi ark an	one de t and u ng unc id uncl	efectiv nchang ler blac hanged	e dot. ged in ck patt l in siz	size ern e in
	Microti	<i>logy</i> Revision 0; UMNH-81201	VID 7	τ \/	<b>^</b> .	l	7 004				Pag	_	28

INOR	LCD GLASS CHIPPING LCD GLASS CHIPPING LCD GLASS GLASS CRACK		Y > S X or Y > S	Reject Reject	
	CHIPPING LCD GLASS	S X S S	X or Y > S	Reject	
		T			
		Y Y	Y > (1/2) T	Reject	
	LCD GLASS SCRIBE DEFECT	$A_{\tau}^{\downarrow} \xrightarrow{\models} a^{\rightarrow} \xrightarrow{\downarrow} B$		Reject DING	
INOR	CHIPPING	T	= (x+y)/2 > 2.5 mm Reject		
INOR	LCD GLASS CHIPPING ( ON THE TERMINAL SURFACE )	T Z Z X	Y > (1/3) T	Reject	
	LCD GLASS CHIPPING	X Y Z	Y > T	Reject	
11	NOR	JOR SCRIBE DEFECT   NOR LCD GLASS CHIPPING (ON THE TERMINAL AREA )   NOR LCD GLASS CHIPPING (ON THE TERMINAL SURFACE )   NOR LCD GLASS	JOR SCRIBE DEFECT $\Lambda_{T}^{\pm}_{T=a^{-1}}$ B   NOR LCD GLASS CHIPPING (ON THE TERMINAL AREA ) T X Y   NOR LCD GLASS CHIPPING (ON THE TERMINAL SURFACE ) T Y Y   NOR LCD GLASS CHIPPING (ON THE TERMINAL SURFACE ) T Y Y   NOR LCD GLASS CHIPPING (ON THE TERMINAL SURFACE ) T Y Y   NOR LCD GLASS CHIPPING T Y Y	JORSCRIBE DEFECT $A_{T}^{+}_{Fa}$ 2. B : ACCOR TO DIMENORLCD GLASS CHIPPING (ON THE TERMINAL AREA )T $X$ $Y$ $= (x+y)/2 > 2.5$ NORLCD GLASS CHIPPING (ON THE TERMINAL SURFACE )T $Y$ $Y > (1/3) T$ NORLCD GLASS CHIPPING (ON THE TERMINAL SURFACE )T $Y$ $Y > (1/3) T$	

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